LH1605 Switching Regulator

INTRODUCTION

The LH1605 is the first in a family of high-efficiency switching regulators designed to simplify power conversion while minimizing power losses. It can deliver 5 amps continuous output current and operate over a wide range of input and output voltages. In classic step-down voltage regulator applications it requires only 4 external parts: a resistor, 2 capacitors and an inductor. The device is housed in a standard 8-pin TO-3 power package containing a temperature compensated voltage reference, an error amplifier, a pulsewidth modulator with programmable operating frequency and a high current output switch and steering diode. Typical performance of the LH1605 is summarized in Table I.

This discussion details LH1605 operating theory and analyzes device power considerations. It also explains DC/DC conversion using the LH1605 and presents design criteria and examples. A section suggesting other typical LH1605 applications is included, as in an appendix listing suppliers of capacitors, magnetic components and heat sinks suitable for use with the LH1605.

TABLE I. LH1605 Typical Performance Characteristics

	Parameter	Value
lo	Continuous Output Current	5A
VIN	Input Voltage	10V-35V
Vo	Output Voltage	3V-30V
Vs	Switch Saturation Voltage,	1.4V
	$I_{OUT} = 4A$	
ΔV _R	Line Regulation of	20 mV
	Reference Voltage	
η	Efficiency	70%
$\theta_{\rm JC}$	Thermal Resistance	5°C/W

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THEORY OF OPERATION

Unlike linear regulators, which rely on a linear series element to control the flow of power to a load, switching regulators utilize a series switch which is either open or closed (*Figure 1*). Average output voltage is proportional to the ratio of switch closed time to switch open time, expressed as the switch duty cycle.





FIGURE 1b. Switching Regulator

A switching regulator achieves a constant average output by varying the switch duty cycle according to output feedback.

In the LH1605 (*Figure 2*), a pulse-width modulator operating at a frequency determined by an external capacitor, C_T , varies the duty cycle of a Darlington transistor switch according to the feedback voltage applied to pin 3.



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To achieve precise regulation, the difference between the feedback voltage and the internal reference is amplified, creating an error voltage which varies inversely with the feedback signal. This error voltage is compared to a periodic ramp voltage created across C_T by a constant current source within the oscillator. Comparator output is low until the ramp voltage exceeds the error voltage. *Figure 3* illustrates how fluctuations in error voltage alter the duty cycle of the comparator's output.

The comparator output is logically combined with a blanking pulse created by the oscillator while discharging C_T. This produces a constant frequency switch drive signal whose leading edge coincides with the falling edge of the blanking pulse. Note that, because the oscillator blanking pulse is shorter than the combined delay time of the drive signal buffer and the switch transistors, the LH1605 can run at 100% duty cycle for sufficiently low feedback voltage on pin 3.





EFFICIENCY CALCULATIONS

Because high-efficiency is the principle advantage of switched-mode power conversion, switching regulator losses are an important design concern. Losses and efficiency of the LH1605 can be calculated with the following equations. (Note: pin 7 is grounded; $I_{\rm O}$ = average current output at pin 8.)

$$\frac{1}{f_{O}} = t_{ON} + t_{OFF}$$
(2)

Duty Cycle (D) =

$$\frac{t_{ON}}{t_{ON} + t_{OFF}} = \frac{V_O + V_F}{V_{IN} - V_S + V_F}$$

Transistor DC Losses (P_T) =

 $V_{\rm S} \times I_{\rm O} \times {\rm D}$

ansistor Switching Losses (P_S) =
$$(t + t_1 + 2t_2)$$
 for

$$(V_{IN} + V_F) \times I_O \times \frac{(t_f + t_f + 2t_S) I_O}{2}$$

.

Diode DC Losses (P_D) =

Dr

$$v_{F} \times I_{O} \times (I - D)$$

$$rac{V_{IN}^2}{300} imes D$$

$$\frac{(V_{IN} - V_S) t_{ON} - (V_F) t_{OFF}}{V_{IOFF}} \times I_O$$

 $t_{ON} + t_{OFF}$

Efficiency (η) =

$$\frac{P_{O}}{P_{IN}} = \frac{P_{O}}{P_{O} + P_{T} + P_{S} + P_{D} + D_{L}}$$
(9)

(8)

As with all switching regulators, the LH1605 requires some external filter to achieve a non-pulsating output. The overall circuit efficiency, therefore, must include power losses in the filter section (discussed later) as well as losses in the LH1605.

From equation 5, it follows that LH1605 efficiency is improved as the operating frequency is reduced. Efficiency can also be improved by adding an external Schottky diode with the LH1605's as shown in *Figure 4*. Schottky diodes exhibit almost no storage time and have a very low forward voltage drop. When using an external Schottky diode, the steering diode at pin 7 should be left open to insure that it contributes no storage delay losses.



FIGURE 4. LH1605 with External Schottky Diode

HEAT SINKING CONSIDERATIONS

Even at moderate output power, there is significant self-heating of the LH1605 due to internal power dissipation. To prevent thermal damage, the junction temperature, T_j , must remain below 150°C under all operating conditions. Some useful expressions for steady state thermal design are given below:

$$\mathsf{P}_{\mathsf{DISS}} = \frac{\mathsf{P}_{\mathsf{O}} - \eta \,\mathsf{P}_{\mathsf{O}}}{\eta} < \frac{\mathsf{T}_{\mathsf{J}(\mathsf{MAX})} - \mathsf{T}_{\mathsf{A}(\mathsf{MAX})}}{\theta_{\mathsf{JC}} + \theta_{\mathsf{CS}} + \theta_{\mathsf{SA}}} \qquad (10)$$

$$\theta_{\rm CS} + \theta_{\rm SA} < \frac{{\sf T}_{\sf J(MAX)} - {\sf T}_{\sf A(MAX)}}{{\sf P}_{\sf DISS}} - \theta_{\sf JC}$$
 (11)

Where:

 θ_{CS}

- $T_{J(MAX)} = \mbox{maximum allowable junction temperature,} \\ 150^{\circ}\mbox{C}. \label{eq:maximum}$
- $T_{A(MAX)} = \mbox{Maximum ambient operating temperature in} \label{eq:tau} \begin{tabular}{lll} \label{eq:tau} \end{tabular} T_{A(MAX)} &= \end{tabular} \begin{tabular}{lll} \end{tabular} \end{tabular} \end{tabular} \end{tabular}$
- θ_{JC} = device junction-to-case thermal resistance, typically 5°C/W.
 - = case-to-heat sink thermal resistance in °C/W.
- θ_{SA} = heat sink-to-ambient thermal resistance in °C/W.

The case-to-heat sink thermal resistance depends on the interface materials used. The following list gives the expected values for various materials.

(3)

(4)

(5)

(6)

(7)

0.003" thick insulating mica without thermal grease 1.30°C/W with thermal grease 0.38°C/W Bare joint

without thermal grease 0.50°C/W with thermal grease 0.15°C/W

Most heat sink manufacturers provide the heat sink-to-ambient thermal resistance under convection as well as forcedair cooling. Appendix A gives a partial list of hardware and manufacturers.

DC/DC CONVERSION

The LH1605 operates only in Buck-type DC/DC converters. A Buck converter produces a positive DC output voltage which is less than its input voltage. It consists of a switching regulator, a steering diode, an inductor and a capacitor (*Figure 5*). During the switch ON time, inductor current, it, builds, flowing to both the capacitor and the load. During to_{CFF}, the magnetic energy stored in the inductor draws current through the diode. The capacitor serves to filter the output voltage by sourcing current while i_L is low and sinking current when i_L is high.

Figure 6 illustrates the current waveforms of the paths labeled in Figure 5.

As the load increases, more current must be supplied to maintain a given output voltage. The switching regulator senses the drop in V_O and increases switch duty cycle to raise the average i_L . Likewise, a reduction in loading causes a reduction in switch duty cycle.







INDUCTOR DESIGN

 ΔI

The primary function of the inductor in a switching converter is to reduce the ripple current flowing to the output node. Inductor current, *Figure 6c*, consists of a DC value equal to the average converter output current, I_O , and a ripple current whose peak-to-peak value is:

$$L = \frac{(V_{\rm IN} - V_{\rm O})}{L} \times t_{\rm ON}$$
(12)

If ΔI_L is greater than $2I_O$, i_L will become zero for a portion of each switching cycle (*Figure 7*), which may result in an unstable output voltage.

To maintain $i_L > 0$, L must be made large enough so that:

$$I_{O(MIN)} > \frac{[V_{IN(MAX)} - V_O]}{2L} \times t_{ON}$$
(13)

Equation 14 conveniently expresses the minimum required inductance as a function of $I_{O(MIN)}$ and the operating frequency, $f_{O}.$

$$L > [V_{IN(MAX)} - V_{O}] \left(\frac{V_{O}}{V_{IN(MAX)}}\right) \\ \times \frac{1}{2f_{O}} \times \frac{1}{I_{O(MIN)}}$$
(14)

The graph in Figure 8 plots L vs $I_{O(MIN)}$ for some common converter parameters.

The next consideration for inductor design is the choice of an appropriate magnetic core. The core must provide the desired inductance without saturating under maximum output conditions. Magnetic core saturation leads to excessive inductor current which jeopardizes output stability and may damage both the switching regulator and the load circuitry it supplies.



FIGURE 7. Inductor Current with $\Delta I_L > 2 I_O$



TL/K/5496-9 FIGURE 8. Inductance vs Minimum Output Current Switching converter inductor cores are normally made of ferrite or molypermalloy powder to minimize core loss at high switching frequencies. The core should provide a closed flux path to minimize radiated noise due to flux leakage. Toroidal and fully enclosed pot cores are popular for this reason.

To further reduce flux leakage, the core winding should be a single layer covering a maximum amount of the winding surface. The number of winding turns necessary for an inductance, L, is:

$$N = 1000 \times \sqrt{\frac{L}{L_{1000}}}$$
 (15)

Core manufacturers specify the nominal inductance, L_{1000} mH per 1000 turns, for a given core as well as the maximum magnetic energy, Ll², that a core can sustain without saturation. Ll² is calculated using L as determined by equation 14 and I equal to the maximum anticipated output current plus $I_{O(MIN)}.$

When using a core with optimum magnetic performance at the desired switching frequency, the I^2R loss in the winding will dominate inductor power losses. This loss,

$$P_1 = I_0^2 \times R_1$$
 (DC winding resistance)

can be reduced by using large diameter copper wire for the core winding.

Many magnetic core manufacturers offer further information on inductor design. Some companies now specialize in supplying pre-wound inductors to meet specific switching converter needs. A partial list of core manufacturers and inductor suppliers is included in Appendix A.

CHOOSING AN OUTPUT CAPACITOR

Ν

The output filter capacitor reduces the peak-to-peak output ripple voltage, e_0 , by integrating the inductor ripple current at the output node. To do this, the capacitor may have to source and sink currents as high as 2A. At these current levels, the drop across the capacitor's effective series resistance, ESR, could dominate e_0 . *Figure 9* shows an example where no amount of capacitance could achieve less than 50 mV output ripple.





Because the ESR of a large capacitor is generally less than that of a small capacitor of similar construction, the easiest way to reduce ESR is to use a large capacitor. ESR can also be reduced by using 2 or more capacitors in parallel. Capacitor leads and the PC board traces connecting them contribute to the ESR and should be made as short as possible. To reduce output voltage spikes due to switching transients, a 0.1 μF ceramic capacitor should be used in parallel with an electrolytic capacitor. A partial list of manufacturers of low ESR capacitors is included in Appendix A.

Equation 17 is a convenient expression for determining the minimum required capacitance as a function of e_0 , f_0 , ESR, and the inductor ripple current.

$$C > \frac{I_{O(MIN)}}{4f_O} \times \frac{1}{e_O - (I_{O(MIN)} \times ESR)}$$
(17)

Figure 10 plots C vs e_{O} for some common converter parameters.



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FIGURE 10. Capacitance vs Output Ripple Voltage

Power loss in a filter capacitor is almost entirely due to ESR. This loss is given by:

$$P_{C} = \left(\frac{I_{O(MIN)}}{2}\right)^{2} \times ESR$$
(18)

FEEDBACK

(16)

The LH1605 regulates output voltage using a single feedback resistor. The resistor, R_f, forms a voltage divider with a 2 k Ω internal resistor from pin 3 of the LH1605 to ground (*Figure 11*). A steady state output voltage is reached when the voltage on pin 3 is approximately equal to the reference voltage on pin 2, about 2.5V.



FIGURE 11. Output Voltage Feedback with LH1605

The output voltage can be programmed by selecting a feedback resistor as follows:

R

$$r = 2 k\Omega \frac{V_{OUT} - 2.5V}{2.5V}$$
 (19)

Figure 12 shows the linear relationship between R_f and V_O .



FIGURE 12. Feedback Resistance vs Output Voltage

CURRENT LIMITING

LH1605 current limiting is best done by pulling down the reference voltage at pin 2. This reduces the output pulsewidth on a cycle-to-cycle basis. Clamping the reference to ground inhibits the output switch and can be done with any general purpose transistor. A 10 μ F capacitor from pin 2 to ground will allow the LH1605 to recover with a soft start from an over-current condition. *Figure 13* illustrates a typical current limit circuit for the LH1605 requiring only two transistors and three resistors.

Although this circuit is effective, it has several shortcomings. The $-2.2 \text{ mV/}^{\circ}\text{C}$ TC of Q1 can cause a 34% drift in the current limit set point over the -25°C to $+85^{\circ}\text{C}$ temperature range, and the relatively large R_S can decrease overall converter efficiency by as much as 10%. Furthermore, a short circuit condition draws significant power from the input supply. Superior performance can be obtained from a foldback current limit with only a slightly higher parts count.

FOLDBACK CURRENT LIMITING

A foldback current limit reduces the current limit threshold as the converter's load increases from an initial overcurrent condition to a complete short circuit. Because short circuit current, I_{SC}, is much less than the initial current limit set point, I_{CL}, a prolonged short circuit draws very little power from the input supply.

In the circuit of *Figure 14*, initial current limit is reached when the output of Q2 reaches 0.6V, $V_{BE(ON)}$ of Q1.

This corresponds to
$$V_{CL} = \frac{0.6V}{A_V}$$
 where
 $A_V = \frac{R2}{R1}$, R1 = R3, R2 = R4. (20)



 V_{CL} is the sum of the voltage drop across R_S and the opposing drop across R_A . As current limit is reached, V_O is reduced, lowering the voltage across R_A . It then requires less current through R_S to create a V_{CL} sufficient to cause further current limiting. This action produces the I-V characteristics shown in *Figure 15*. As the overload is removed, the converter output recovers along the same curve.



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Because the gain of Q2 can be quite large, generally 10 to 20, the sense resistor, R_S , can be made very small, 0.02Ω to 0.06Ω . This significantly improves overall converter efficiency. Another advantage of amplifier gain is increased temperature stability. A gain of 10 reduces I_{CL} drift to about $-3.3~\text{mA}/^\circ\text{C}$ with $R_S=0.06\Omega$

The first step in designing a foldback current limit for the LH1605 is to choose a readily available value for ${\sf R}_S.$ Then the amplifier gain can be determined as a function of ${\sf R}_S$ and the desired short circuit current.

$$A_V = \frac{0.6}{I_{SC} \times R_S}$$
(21)

The relationship between A_V, I_{SC}, and R_S is shown in *Figure* 16. A small capacitor in parallel with R2 and/or R4 may be necessary with high amplifier gains to filter switching noise.



. .

FIGURE 16. Amplifier Gain vs Short Circuit Current and R_S

The resistors R_A and R_B can be found in terms of $\mathsf{V}_O,\,\mathsf{R}_S,$ and the amount of current foldback desired.

$$R_{A} = \frac{R_{B} \times R_{S}}{V_{O}} \left(I_{CL} - I_{SC} \right)$$
(22)

The condition $R_B \ll R1$ should be maintained to insure accuracy in setting $I_{CL}.$ Typical values for these resistors are:

Power loss due to the current limit circuit under normal converter operation is:

$$P_{\rm CL} = I_{\rm O}^2 \times R_{\rm S} \tag{23}$$

Power drained from the input supply with the converter output short circuited cannot be easily expressed due to the nature of the LH1605's control loop while in current limit. The drain, however, can be minimized by using a foldback current limit with a low $I_{SC}.$

Design Example

D

esign requ	irements:
V _{IN(MAX})	= 20V
V _{IN(MIN)}	= 10V
VIN(NOM)	= 14V
Vo	= 5V
eO	= 50 mV
I _{CL}	= 5A
IO(MIN)	= 0.5A
I _{SC}	= 1A
fo	= 25 kHz

Inductor From equation 14:

$$L_{\text{MIN}} = (20V - 5V) \left(\frac{5V}{(20V)}\right) \left(\frac{1}{2}\right) \left(\frac{1}{25 \text{ kHz}}\right) \left(\frac{1}{0.5A}\right)$$

= 150 μH.

The maximum magnetic energy will be:

 $E_{L} = (150 \ \mu H) (5A + 0.5A)^{2} = 4.54 \ mJ.$

A toroidal powdered-iron core from Arnold Engineering, part #SG-0800-0320-T, was chosen for this example because of its high flux density capability. At only 25 kHz switching frequency, a powdered-iron core has very little hysteresis power loss and costs far less than a molypermalloy powder core of comparable flux density capability.

The nominal inductance of this core is 32 mH per 1000 turns. The number of turns required for this design is found using equation 15:

$$N = 1000 \times \sqrt{\frac{150\mu H}{32 \text{ mH}}} = 69 \text{ turns}$$

A single layer winding of this core requires about 5.1 feet of #24 wire which would yield a DC winding resistance of 0.13 Ω . In this case, efficiency can be improved significantly by using a double layer winding of #20 wire with only 0.050 Ω .

Capacitor

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From equation 17:

$$\begin{split} C_{\mathsf{MIN}} &= \left(\frac{0.5\mathsf{A}}{4}\right) \left(\frac{1}{25 \text{ kHz}}\right) \left(\frac{1}{0.05\mathsf{V}-(0.5\mathsf{A}\times\mathsf{ESR}) \,\mathsf{V}}\right) \\ &= \frac{5}{0.05-0.5 \,\mathsf{ESR}} \,\mu\mathsf{F} \end{split}$$

Since no capacitor will meet the needs of this application with ESR $> 0.1\Omega$ at 25 kHz, it is easier in this case to search for a capacitor on the basis of ESR rather than capacitance. Mepco/Electra part #3475GD681M6P3JMBS has a typical ESR at 25 kHz of about 0.06 Ω . For ESR = 0.06 Ω ,

$$C_{MIN} = 250 \ \mu F.$$

This part, rated at 680 $\mu F,$ 6.3 WV_{DC}, is more than adequate for this application.

Feedback

From equation 19:

$$R_{f} = 2 k\Omega \frac{5V - 2.5V}{2.5V} = 2 k\Omega$$

Current Limit

 $R_S = 0.05\Omega$, 1.5W will be used in this application. From equations 21 and 22:

$$\begin{split} A_V &= \frac{0.6V}{1A\times0.05\Omega} = 12, \\ R_A &= R_B \left(\frac{0.05\Omega}{5V}\right) (5A-1A) = 0.04 \ R_B. \end{split}$$

If $R_B = 2 k\Omega$ and $R1 = 100 k\Omega$, then,

 $R_A = 80\Omega$,

 $R2 = R4 = 1.2 M\Omega$,

$$R3 = 100 k\Omega.$$

Operating Frequency

From the LH1605 data sheet graph of $C_{T} \mbox{ vs } f_{O},$ the desired timing capacitor is,

 $C_{T} = 0.001 \ \mu F.$

Input Capacitor

The choice of this capacitor depends upon the source impedance and ripple voltage requirements of the input supply. In most applications,

$$C_{IN} > 50 \ \mu F$$

The complete circuit is shown in Figure 17.

Using LH1605 data sheet information and equations 2–9 of this note, LH1605 efficiency in this design with $V_{\rm IN}=14V$ and $I_O=3A$ is,

$$\eta = \frac{15}{15 + 1.66 + 2.34 + 2.59 + 0.30} = 0.69$$

Equation 11 gives the maximum allowable thermal resistance of heat sink bolted directly to the LH1605 with thermal grease at 50° C ambient temperature:

$$\theta_{SA} = \frac{(150^{\circ}C - 50^{\circ}C)}{6.89W} - 5^{\circ}C/W - 0.15^{\circ}C/W$$
$$= 9.4^{\circ}C/W$$

By including the power losses found in equations 16, 18 and 23, equation 9 yields the overall converter efficiency:

 $\eta = \frac{15}{21.89 + 0.45 + 0.004 + 0.45} = 0.66$

So, in this design example, the converter dissipates only 7.8W, whereas a linear regulator under identical input/output conditions would dissipate 27W.

TYPICAL APPLICATIONS

Figure 18 shows a typical LH1605 Buck regulator application powered from the rectified output of a step-down transformer. Because LH1605 regulation is more efficient than equivalent linear regulation, the size and power rating of the transformer and bridge rectifier can be much smaller. Table II contains component values for several converters with this topology.



f _O = kHz			IO (MIN)				
e _O = 50 mV			1.0A		0.5A]
ESR _C (Ω)	V _{IN (MAX)} (V)	V _O (V)	L _{MIN} (μΗ)	C _{MIN} (μF)	L _{MIN} (μΗ)	C _{MIN} (μF)	R f (Ω)
0.02	12	5	59	334	117	125	2k
0.03	15	5	67	500	134	143	2k
0.04	25	12	125	1000	250	167	7.6k
0.05	35	24	151	_	302	200	17.2k

Power Distribution Pre-Regulator

DC Motor Speed Controller

In applications requiring very low output ripple voltage, the LH1605 can be used as a pre-regulator to improve system performance and efficiency (*Figure 19*). By pre-regulating the input to the linear regulators to 5.8V, line frequency ripple is virtually eliminated from the 5V output. The 25 kHz switching ripple is attenuated 70 dB by the LM2931's giving less than 1 mV total output noise voltage.

Figure 20 shows how an LH1605 can be connected as a fractional-horsepower, DC motor speed controller. The constant average output voltage of the LH1605 is set with a single resistor, R_f, as it is in Buck converter applications. Current limiting may be required to protect the LH1605 during start-up of motors with low armature resistance.



Multiple Outputs

It is possible, as *Figure 21* suggests, to obtain any number of outputs from a single LH1605 provided there is one primary output in a Buck configuration drawing sufficient output current. During toFF, the voltage across the primary inductance is (V_O + V_f). The voltage across any secondary windings wound on the same core is N_S/N_p (V_O + V_f). Because V_O is regulated and V_f is nearly constant, the voltages on the secondaries are also constant.

During t_{ON} , the diodes in the secondaries are reverse biased so all secondary power comes from the filter capacitors, C1 and C2. During t_{OFF} , the diodes conduct, and the capacitors are recharged. To ensure stable output voltages,

the Buck converter's output power must be greater than that of the secondaries. In the circuit of *Figure 21*, I_O \geq 0.8A in the 5V primary is necessary in order to have 100 mA capability in the \pm 12V secondaries.

REFERENCES

- 1. National Semiconductor, 1982 Hybrid Products Databook.
- 2. National Semiconductor, "LH1605 5 Amp, High Efficiency Switching Regulator" datasheet.
- Abraham I. Pressman, "Switching and Linear Power Supply, Power Converter Design", Hyden Book Company, 1977.





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Following is a partial list of socke				ith t		
LH1605. National Semiconductor	Corporation assumes no respo	onsibility for their qualit	y or availability.			
8-LEAD TO-3 HARDWARE						
Sockets	Heat Sinks	М	ica Washers			
Robinson Nugent 0002011 Azimuth 6028 (test socket)	Thermalloy 2266B (35° IERC LAIC 3B4CB IERC HP1-TO3-33CB (AAVID 5791B	B				
AAVID ENGINEERING 30 Cook Court	IERC 135 W. Magnolia Blv	d.	ROBINSON NUGENT INC. 800 E. 8th St.			
Laconia, New Hampshire 03246			New Albany, IN 47150			
AZIMUTH ELECTRONICS 2377 S. El Camino Real San Clemente, CA 92672	KEYSTONE ELECTRC 49 Bleecker St. New York, N.Y. 1001		HERMALLOY P. O. Box 34829 Dallas, Texas 75234	D. Box 34829		
MAGNETIC COMPONENTS MAN	IUFACTURERS					
Cores						
ARNOLD ENGINEERING CO. 300 West St.	FERROXCUBE 5038 Kings Highway	MAGNETICS P. O. Box 391	FERRONICS, INC. 60 N. Lincoln Rd.			
Marengo, ILL. 60152	Saugerties, N.Y. 12477	Butler, PA 1600	1 E. Rochester, N.Y.	144		
Pre-Wound Inductors GFS MANUFACTURING CO., INC 6 Progress Drive Dover, N.H. 03820	6	NCO ELECTRONICS 0 Jefryn Boulevard ast Deer Park, N.Y. 11	729			
	E	usi Deer i din, in. i . i i i				
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